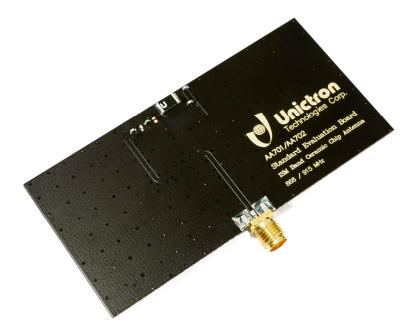
ISM 915 MHz Ceramic Chip Antenna (AA702) with Evaluation Board

Engineering Specification

1. Product Number

H 2 B 1 S G 1 A 2 C 0 3 0 0



2. Features

- *Stable and reliable in performances
- *Low profile, compact size
- *RoHS compliance
- *SMT processes compatible

3. Applications

- *ISM 915 MHz Band applications
- *IoT applications
- *IEEE 802.11ah/ Wi-Fi Certified HaLow technology

4. Description

Unictron's AA702 ceramic chip antenna is designed for ISM 915MHz band applications, covering frequencies 909~919 MHz. Fabricated with proprietary design and processes, AA702 shows excellent performance and is fully compatible with SMT processes which can decrease the assembly cost and improve device 2016ality and consistency.

Unictron Technologies Corp.

詠業科技股份有限公司

Unictron Technologies Corporation Website:www.unictron.com

THIS DRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF UNICTRON TECHNOLOGIES CORPORATION AND SHALL NOT BE REPRODUCED OR USED AS THE BASIS FOR THE MANUFACTURE OR SALE OF APPARATUS OR DEVICES WITHOUT PERMISSION

Prepared by : Xenia Designed by : Phillip Checked by : Mike Approved by : Herbert

TITLE: ISM 915 MHz Ceramic Chip Antenna (AA702) with Evaluation Board Engineering Specification

DOCUMENT NO.

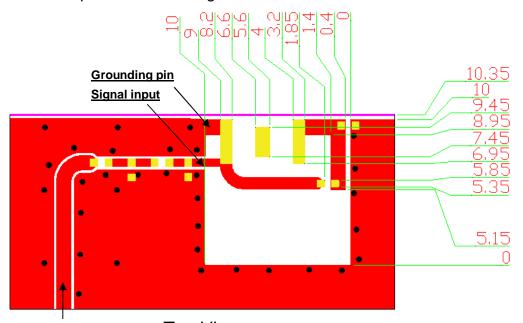
H2B1SG1A2C0300

5. Layout Guide & Electrical Specifications

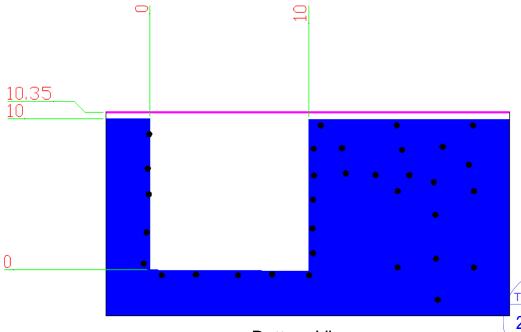
5-1. Layout Guide (unit: mm)

Solder Land Pattern:

The solder land pattern (gold marking areas) is shown below. Recommendation on matching circuit will be provided according to customer's installation conditions.



Transmission Line with 50Ω Impedance Characteristic Top View



Unictron
Technologies Corp.

2016-10-20

Bottom View

Document Control



詠業科技股份有限公司

Unictron Technologies Corporation Website:www.unictron.com THIS DRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF UNICTRON TECHNOLOGIES CORPORATION AND SHALL NOT BE REPRODUCED OR USED AS THE BASIS FOR THE MANUFACTURE OR SALE OF APPARATUS OR DEVICES WITHOUT PERMISSION

Prepared by : Xenia Designed by : Phillip Checked by : Mike Approved by : Herbert

TITLE: ISM 915 MHz Ceramic Chip Antenna (AA702) with Evaluation Board Engineering Specification

DOCUMENT NO.

H2B1SG1A2C0300

5-2. Electrical Specifications (Evaluation Board Dimensions: 80 x 40 mm²) 5-2-1. Electrical Table

Charact	eristics	Specifications	Unit
Outline Dimensions		5.0 x 3.0 x 0.5	mm
Ground Plane Dime	nsions	80 x 40	mm
Working Frequency		909~919	MHz
VSWR (@ center fre	equency)*	2 Max.	
Characteristic Impedance		50	Ω
Polarization		Linear Polarization	
Peak Gain	(@015 MH¬)	0.8 (typical)	dBi
Efficiency	(@915 MHz)	60 (typical)	%

^{*}Center frequency means the frequency with the lowest value in return loss of the chip antenna on the evaluation board.

Unictron
Technologies Corp.

2016-10-20

Document



詠業科技股份有限公司

Unictron Technologies Corporation Website:www.unictron.com

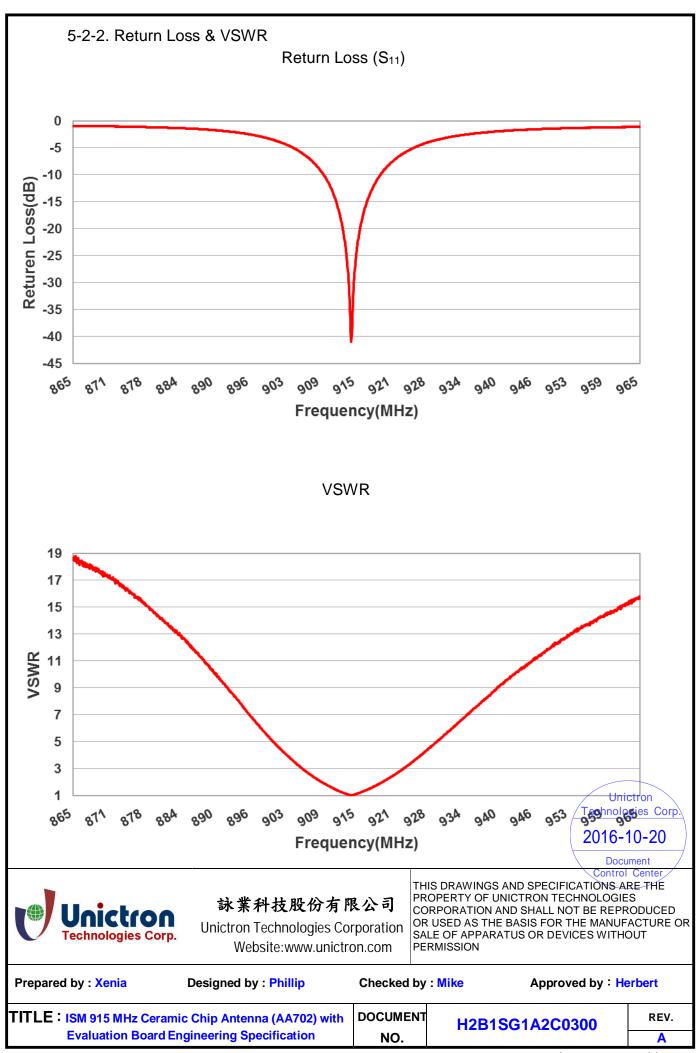
THIS DRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF UNICTRON TECHNOLOGIES CORPORATION AND SHALL NOT BE REPRODUCED OR USED AS THE BASIS FOR THE MANUFACTURE OR SALE OF APPARATUS OR DEVICES WITHOUT PERMISSION

Prepared by : Xenia Designed by : Phillip Checked by : Mike Approved by : Herbert

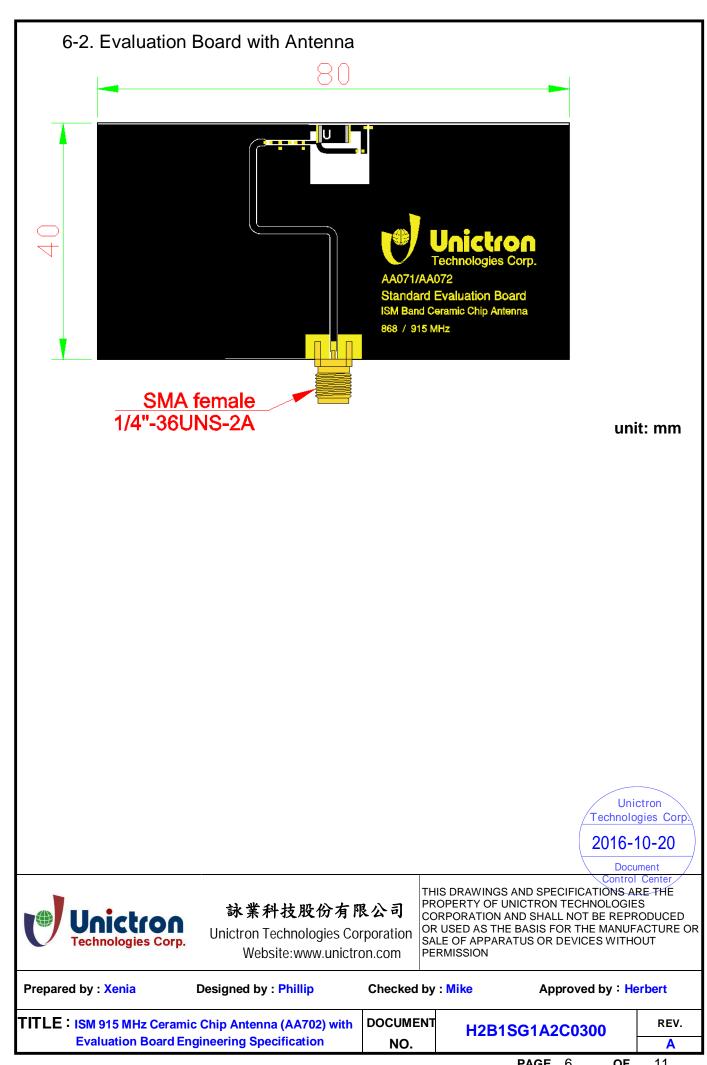
TITLE: ISM 915 MHz Ceramic Chip Antenna (AA702) with Evaluation Board Engineering Specification

DOCUMENT NO.

H2B1SG1A2C0300

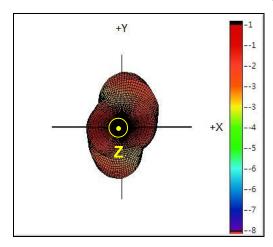


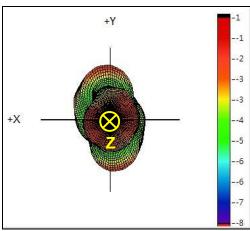
6. **Outline Dimensions of Antenna & Evaluation Board (unit: mm)** 6-1. Antenna Dimensions **♠**5±0.15 **(A)** Top View **Left View** Front View **Right View** (0.75)NOTE: 1.All materials are RoHS compliant. 2." A~© " Critical Dimensions. 3."()" Reference Dimensions. **Bottom View PIN Definitions** PIN₃ PIN1 PIN₂ **Top View Bottom View** PIN 1 2 3 Mictron echnologies Corp **Soldering Pad** Signal Tuning / Ground 2016-10-20 Document THIS DRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF UNICTRON TECHNOLOGIES 詠業科技股份有限公司 CORPORATION AND SHALL NOT BE REPRODUCED OR USED AS THE BASIS FOR THE MANUFACTURE OR **Unictron Technologies Corporation** SALE OF APPARATUS OR DEVICES WITHOUT Website:www.unictron.com PERMISSION Prepared by: Xenia Designed by: Phillip Checked by: Mike Approved by : Herbert **DOCUMENT** TITLE: ISM 915 MHz Ceramic Chip Antenna (AA702) with REV. H2B1SG1A2C0300 **Evaluation Board Engineering Specification** NO. Α

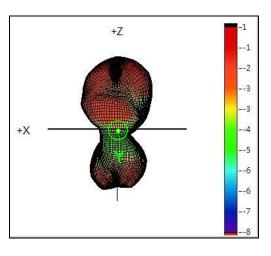


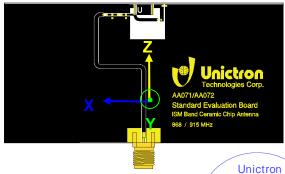
7. Radiation Pattern (with 80 x 40 mm² Evaluation Board)

7-1. 3D Gain Pattern @ 915 MHz (unit: dBi)









Technologies Corp.

2016-10-20

Document



詠業科技股份有限公司

Unictron Technologies Corporation Website:www.unictron.com

THIS DRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF UNICTRON TECHNOLOGIES CORPORATION AND SHALL NOT BE REPRODUCED OR USED AS THE BASIS FOR THE MANUFACTURE OR SALE OF APPARATUS OR DEVICES WITHOUT PERMISSION

Prepared by : Xenia Designed by : Phillip Checked by : Mike Approved by : Herbert

TITLE: ISM 915 MHz Ceramic Chip Antenna (AA702) with Evaluation Board Engineering Specification

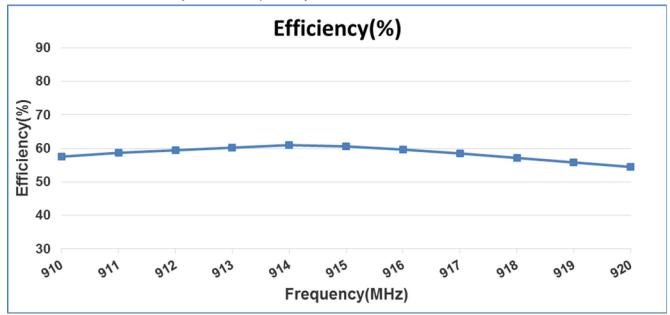
DOCUMENT NO.

H2B1SG1A2C0300

7-2. 3D Efficiency Table

Frequency (MHz)	910	911	912	913	914	915	916	917	918	919	920
Efficiency (dB)	-2.4	-2.3	-2.3	-2.2	-2.1	-2.2	-2.2	-2.3	-2.4	-2.5	-2.6
Efficiency (%)	57.6	58.6	59.5	60.1	61.0	60.6	59.7	58.4	57.1	55.8	54.4
Peak Gain (dBi)	0.6	0.7	0.7	0.8	0.9	0.8	0.9	0.8	0.7	0.6	0.5

7-3. 3D Efficiency vs. Frequency



Unictron
Technologies Corp.

2016-10-20

Document



詠業科技股份有限公司

Unictron Technologies Corporation Website:www.unictron.com

THIS DRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF UNICTRON TECHNOLOGIES CORPORATION AND SHALL NOT BE REPRODUCED OR USED AS THE BASIS FOR THE MANUFACTURE OR SALE OF APPARATUS OR DEVICES WITHOUT PERMISSION

Prepared by : Xenia Designed by : Phillip Checked by : Mike Approved by : Herbert

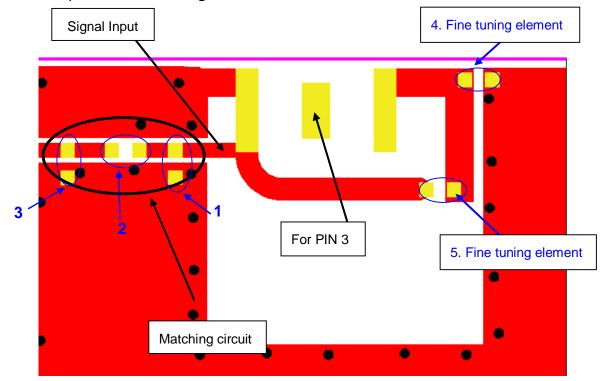
TITLE: ISM 915 MHz Ceramic Chip Antenna (AA702) with Evaluation Board Engineering Specification

DOCUMENT NO.

H2B1SG1A2C0300

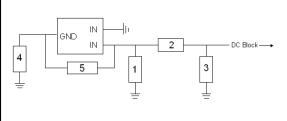
8. Frequency tuning and Matching circuit

8-1. Chip antenna tuning scenario:



8-2. Matching circuit:

With the following recommended values of matching and tuning components, the center frequencies will be about 915 MHz at our standard 80x40 mm² evaluation board. However, these are typical reference values which may need to be changed when circuit boards or part vendors are different.



System Matching Circuit Component						
Location	Description	Vendor	Tolerance			
1	N/A*	-	-			
2	2.7nH, (0402)	MURATA	±0.1nH			
3	0.2pF, (0402)	MURATA	±0.05pF			
4 Fine tuning element	12pF, (0402)	MURATA	±2% Unictron			
5 Fine tuning element	0.8pF, (0402)	MURATA 20	1160105p20 Document			



詠業科技股份有限公司

Unictron Technologies Corporation Website:www.unictron.com

THIS DRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF UNICTRON TECHNOLOGIES CORPORATION AND SHALL NOT BE REPRODUCED OR USED AS THE BASIS FOR THE MANUFACTURE OR SALE OF APPARATUS OR DEVICES WITHOUT PERMISSION

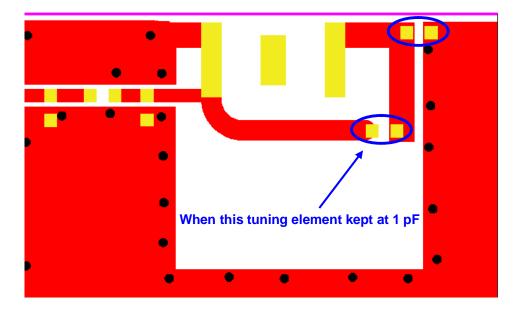
Prepared by : Xenia Designed by : Phillip Checked by : Mike Approved by : Herbert

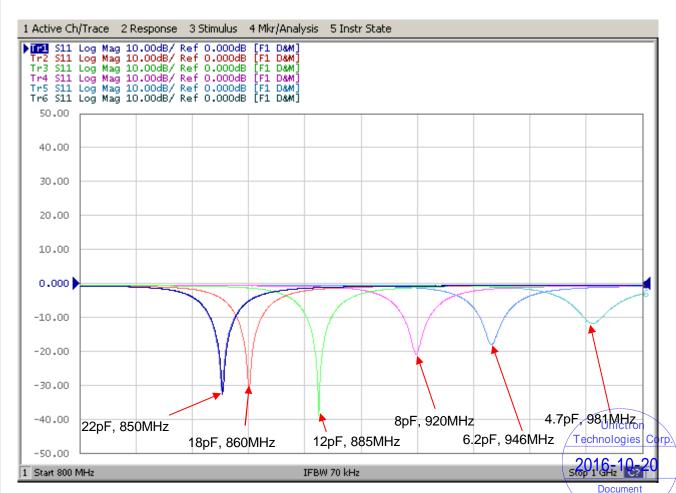
TITLE: ISM 915 MHz Ceramic Chip Antenna (AA702) with Evaluation Board Engineering Specification

DOCUMENT NO.

H2B1SG1A2C0300

8-3. Reference for frequency tuning element







詠業科技股份有限公司

Unictron Technologies Corporation Website:www.unictron.com

THIS DRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF UNICTRON TECHNOLOGIES CORPORATION AND SHALL NOT BE REPRODUCED OR USED AS THE BASIS FOR THE MANUFACTURE OR SALE OF APPARATUS OR DEVICES WITHOUT PERMISSION

Prepared by : Xenia Designed by : Phillip Checked by : Mike Approved by : Herbert

TITLE: ISM 915 MHz Ceramic Chip Antenna (AA702) with Evaluation Board Engineering Specification

DOCUMENT NO.

H2B1SG1A2C0300

9. Reminders for users of Unictron's AA702 ceramic chip antennas

- 9-1. This chip antenna is made of ceramic materials which are relatively more rigid and brittle compared to printed circuit board materials. Bending of circuit board at the locations where chip antenna is mounted may cause the cracking of solder joints or antenna itself.
- 9-2. Punching/cutting of the break-off tab of PCB panel may cause severe bending of the circuit board which may result in cracking of solder joints or chip antenna itself. Therefore break-off tab shall be located away from the installation site of chip antenna.
- 9-3. Be cautious when ultrasonic welding process needs to be used near the locations where chip antennas are installed. Strong ultrasonic vibration may cause the cracking of chip antenna solder joints.

10. Operating & Storage Conditions

10-1. Operating

(1) Maximum Input Power: 2 W

(2) Operating Temperature: -40°C to 85°C

10-2. Storage

(2) Relative Humidity: 20% to 70%

(3) Shelf Life: 1 year

11. Notice

All specifications are subject to change without notice.

Unictron
Technologies Corp.

2016-10-20

Document



詠業科技股份有限公司

Unictron Technologies Corporation Website:www.unictron.com

THIS DRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF UNICTRON TECHNOLOGIES CORPORATION AND SHALL NOT BE REPRODUCED OR USED AS THE BASIS FOR THE MANUFACTURE OR SALE OF APPARATUS OR DEVICES WITHOUT PERMISSION

Prepared by : Xenia Designed by : Phillip Checked by : Mike Approved by : Herbert

TITLE: ISM 915 MHz Ceramic Chip Antenna (AA702) with Evaluation Board Engineering Specification

DOCUMENT NO.

H2B1SG1A2C0300